

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10761412
<b>Filing Date:</b>	22-Jan-2004
<b>Title of Invention:</b>	METHOD OF FORMING BUMPS ON A WAFER UTILIZING A POST-HEATING OPERATION, AND AN APPARATUS THEREFORE
<b>First Named Inventor/Applicant Name:</b>	Makoto Imanishi
<b>Filer:</b>	W. Douglas Hahm/Ebony Jennings
<b>Attorney Docket Number:</b>	2004-0092

Filed as Large Entity

### Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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**Basic Filing:**

**Pages:**

**Claims:**

**Miscellaneous-Filing:**

**Petition:**

**Patent-Appeals-and-Interference:**

Post-Allowance-and-Post-Issuance:

Utility Appl issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Extension-of-Time:</b>				
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1740</b>